19-0724; Rev 0; 5/07

2.5Gbps PCI Express Passive Switches

General Description

The MAX4888/MAX4889 high-speed passive switches route PCI Express® (PCIe) data between two possible destinations. The MAX4888 is a quad single-pole/double-throw (4 x SPDT) switch ideally suited for switching two half lanes of PCIe data between two destinations. The MAX4889 is an octal single-pole/double-throw (8 x SPDT) switch ideal for switching four half lanes of PCIe data between four destinations. The MAX4888/MAX4889 feature a single digital control input (SEL) to switch signal paths.

The MAX4888/MAX4889 are fully specified to operate from a single 3.0V to 3.6V power supply and also operate down to +1.65V. The MAX4888 is available in a 3.5mm x 5.5mm, 28-pin TQFN package. The MAX4889 is available in a 3.5mm x 9.0mm, 42-pin TQFN package. Both devices operate over the -40°C to +85°C temperature range.

Applications

Desktop Computers

Servers/Storage Area Networks

Laptops

PCI Express is a registered trademark of PCI-Sig Corp.

Features

- **Single 1.65V to 3.6V Power-Supply Voltage**
- **Low Same-Pair Skew of 7ps**
- **Low 120µA (Max) Quiescent Current**
- **Supports PCIe Gen I Data Rates**
- **Flow-Through Pin Configuration for Ease of Layout**
- **Industry-Compatible Pinout**
- **Lead-Free Packaging**

Ordering Information/ Selector Guide

PART	PIN-PACKAGE	CONFIGURATION	PKG CODE
MAX4888ETI+	28 TQFN-EP*	Two Half Lanes	T283555-1
MAX4889ETO+	42 TQFN-EP*	Four Half Lanes	T423590M-1

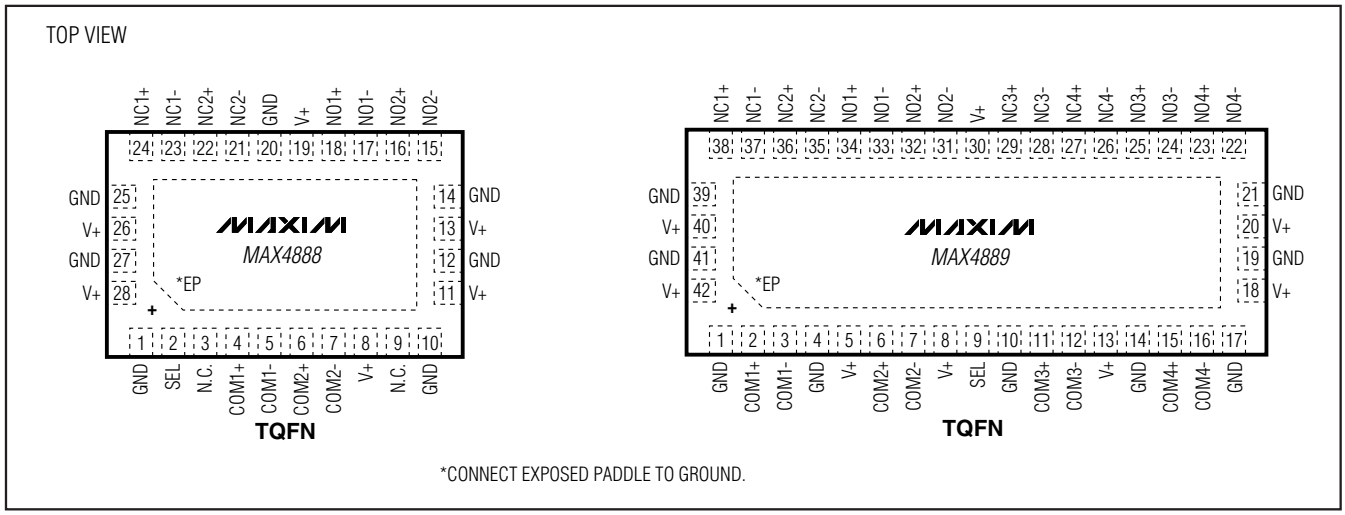
Note: *All devices are specified over the -40°C to +85°C operating temperature range.*

+Denotes lead-free package.

**EP = Exposed paddle.*

Typical Application Circuit appears at end of data sheet.

Pin Configurations



*CONNECT EXPOSED PADDLE TO GROUND.

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

(All voltages referenced to GND, unless otherwise noted.)
V+ .....-0.3V to +4V
SEL, COM__, NO__, NC__ (Note 1) .....-0.3V to (V+ + 0.3V)
I COM__ - NO__ I, I COM__ - NC__ I (Note 1).....0 to 2V
Continuous Current (COM_ to NO__/NC__) .....±70mA
Peak Current (COM__ to NO__/NC__)
(pulsed at 1ms, 10% duty cycle).....±70mA
Continuous Current (SEL).....±30mA
Peak Current (SEL)
(pulsed at 1ms, 10% duty cycle).....±150mA

Continuous Power Dissipation (T_A = +70°C)
28-Pin TQFN (derate 20.8mW/°C above +70°C) 1666.7mW
42-Pin TQFN (derate 35.7mW/°C above +70°C) 2857.1mW
Operating Temperature Range .....-40°C to +85°C
Storage Temperature Range .....-65°C to +150°C
Lead Temperature (soldering, 10s) .....+300°C
Junction Temperature.....+150°C

Note 1: Signals on SEL, NO__, NC__ or COM__ exceeding V+ or GND are clamped by internal diodes. Limit forward-diode current to maximum current rating.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V+ = 3.0V to 3.6V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V+ = 3.3V, T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
ANALOG SWITCH						
Analog-Signal Range	$V_{COM\_}$, $V_{NO\_}$, $V_{NC\_}$		-0.1		(V+ - 1.2)	V
Voltage Between COM and NO/NC	$\lvert V_{COM\_} - V_{NO\_} \rvert$, $\lvert V_{COM\_} - V_{NC\_} \rvert$		0		1.8	V
On-Resistance	R_{ON}	V+ = 3.0V, $I_{COM\_}$ = 15mA, $V_{NO\_}$ or $V_{NC\_}$ = 0V, 1.8V		7		Ω
On-Resistance Match Between Pairs of Same Channel	ΔR_{ON}	V+ = 3.0V, $I_{COM\_}$ = 15mA, $V_{NO\_}$ or $V_{NC\_}$ = 0V (Notes 3, 4)		0.1	1	Ω
On-Resistance Match Between Channels	ΔR_{ON}	V+ = 3.0V, $I_{COM\_}$ = 15mA, $V_{NO\_}$ or $V_{NC\_}$ = 0V (Notes 3, 4)		0.6	2	Ω
On-Resistance Flatness	$R_{FLAT(ON)}$	V+ = 3.0V, $I_{COM\_}$ = 15mA $V_{NO\_}$ or $V_{NC\_}$ = 0V, 1.8V (Notes 4, 5)		0.06	2	Ω
NO_ or NC_ Off-Leakage Current	$I_{NO\_(OFF)}$ $I_{NC\_(OFF)}$	V+ = 3.6V; $V_{COM\_}$ = 0V, 1.8V; $V_{NO\_}$ or $V_{NC\_}$ = 1.8V, 0V	-1		+1	µA
COM_ On-Leakage Current	$I_{COM\_(ON)}$	V+ = 3.6V; $V_{COM\_}$ = 0V, 1.8V; $V_{NO\_}$ or $V_{NC\_}$ = $V_{COM\_}$ or unconnected	-1		+1	µA

ELECTRICAL CHARACTERISTICS (continued)

(V+ = 3.0V to 3.6V, T_A = -40°C to +85°C, unless otherwise noted. Typical values are at V+ = 3.3V, T_A = +25°C.) (Note 2)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DYNAMIC							
Turn-On Time	t_{ON}	$V_{NO\_}$ or $V_{NC\_}$ = 1.0V, R_L = 50Ω, Figure 1			90	250	ns
Turn-Off Time	t_{OFF}	$V_{NO\_}$ or $V_{NC\_}$ = 1.0V, R_L = 50Ω, Figure 1			10	50	ns
Propagation Delay	t_{PD}	R_S = R_L = 50Ω, unbalanced, Figure 2			50		ps
Output Skew Between Pairs	t_{SK1}	R_S = R_L = 50Ω, unbalanced; skew between any two pairs, Figure 2			50		ps
Output Skew Between Same Pair	t_{SK2}	R_S = R_L = 50Ω, unbalanced; skew between two lines on same pair, Figure 2			10		ps
On-Loss	G_{LOS}	R_S = R_L = 50Ω, unbalanced, Figure 3	1MHz < f < 100MHz		-0.5		dB
			500MHz < f < 1.25GHz		-1.4		
Crosstalk	V_{CT1}	Crosstalk between any two pairs, R_S = R_L = 50Ω, unbalanced, Figure 3	f = 50MHz		-53		dB
			f = 1.25GHz		-32		
Signaling Data Rate	BR	R_S = R_L = 50Ω			3.0		Gbps
Off-Isolation	V_{ISO}	Signal = 0dBm, R_S = R_L = 50Ω, Figure 3	f = 10MHz		-56		dB
			f = 1.25GHz		-26		
NO_/NC_ Off-Capacitance	$C_{NO\_/NC\_(OFF)}$	Figure 4			1		pF
COM_ On-Capacitance	$C_{COM\_(ON)}$	Figure 4			2		pF
LOGIC INPUT							
Input-Logic Low	V_{IL}					0.5	V
Input-Logic High	V_{IH}			1.4			V
Input-Logic Hysteresis	V_{HYST}				100		mV
Input Leakage Current	I_{IN}	V_{SEL} = 0V or V+		-1		+1	µA
POWER SUPPLY							
Power-Supply Range	V+			1.65		3.60	V
V+ Supply Current	I+	V_{SEL} = 0V or V+	MAX4888			60	µA
			MAX4889			120	

Note 2: All units are 100% production tested at T_A = +85°C. Limits over the operating temperature range are guaranteed by design and characterization and are not production tested.

Note 3: $\Delta R_{ON} = R_{ON\ (MAX)} - R_{ON\ (MIN)}$.

Note 4: Guaranteed by design. Not production tested.

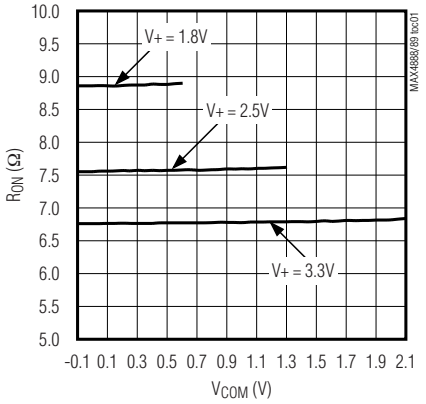
Note 5: Flatness is defined as the difference between the maximum and minimum value of on-resistance as measured over the specified analog signal range.

2.5Gbps PCI Express Passive Switches

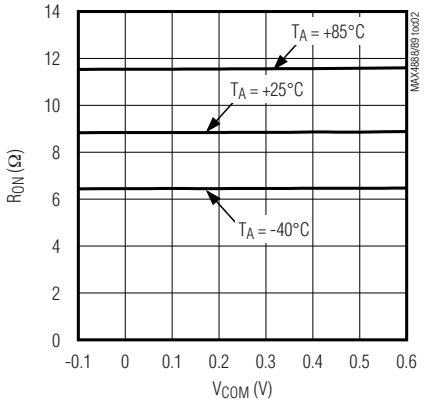
Typical Operating Characteristics

(T_A = +25°C, unless otherwise noted.)

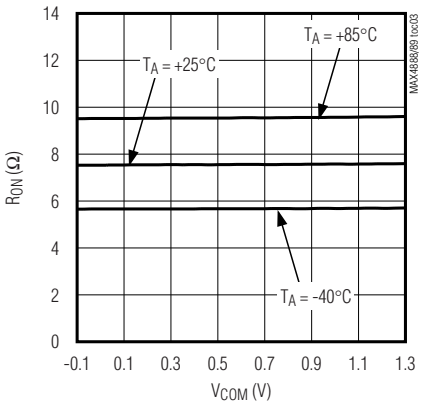
ON-RESISTANCE vs. V_{COM}



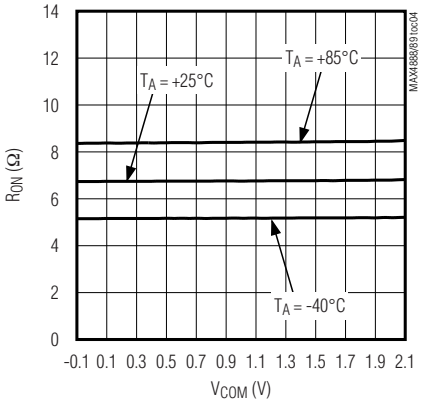
ON-RESISTANCE vs. V_{COM} (V+ = 1.8V)



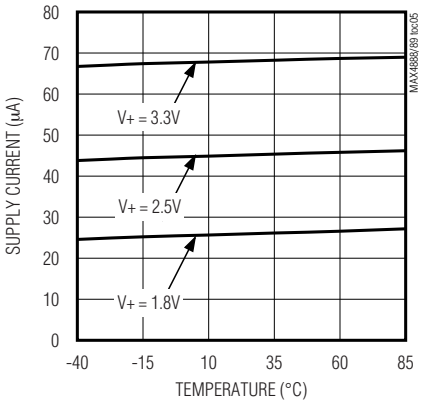
ON-RESISTANCE vs. V_{COM} (V+ = 2.5V)



ON-RESISTANCE vs. V_{COM} (V+ = 3.3V)



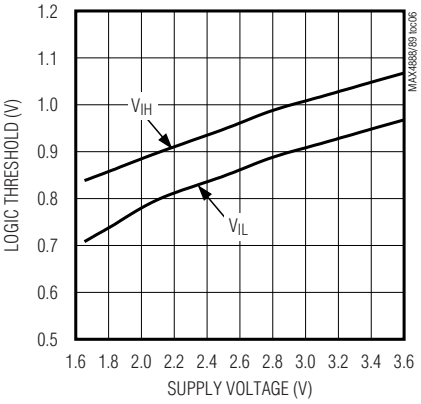
SUPPLY CURRENT vs. TEMPERATURE (MAX4888)



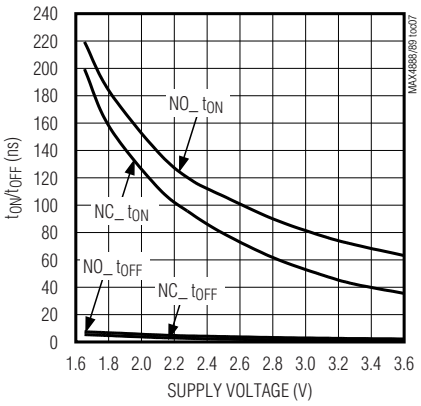
Typical Operating Characteristics (continued)

(T_A = +25°C, unless otherwise noted.)

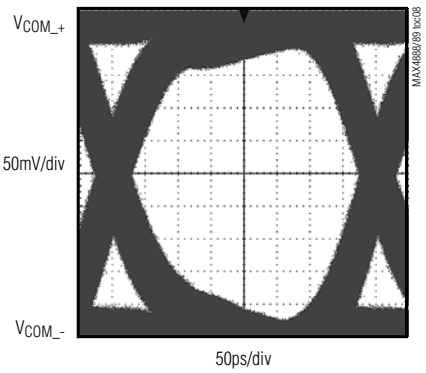
LOGIC THRESHOLD vs. SUPPLY VOLTAGE



TURN-ON/-OFF TIME vs. SUPPLY VOLTAGE

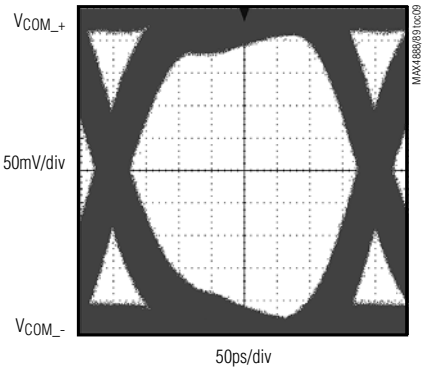


EYE DIAGRAM
(V+ = 1.8V, f = 1.25GHz,
600mVP-P PRBS SIGNAL, RS = RL = 50Ω)†



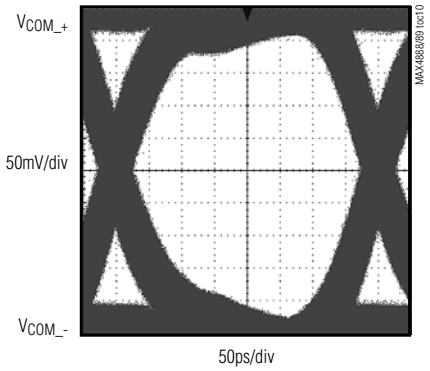
*PRBS = PSEUDORANDOM BIT SEQUENCE
†GEN I; 2.5Gps; UI = 400ps

EYE DIAGRAM
(V+ = 2.5V, f = 1.25GHz,
600mVP-P PRBS SIGNAL, RS = RL = 50Ω)†



*PRBS = PSEUDORANDOM BIT SEQUENCE
†GEN I; 2.5Gps; UI = 400ps

EYE DIAGRAM
(V+ = 3.3V, f = 1.25GHz,
600mVP-P PRBS SIGNAL, RS = RL = 50Ω)†



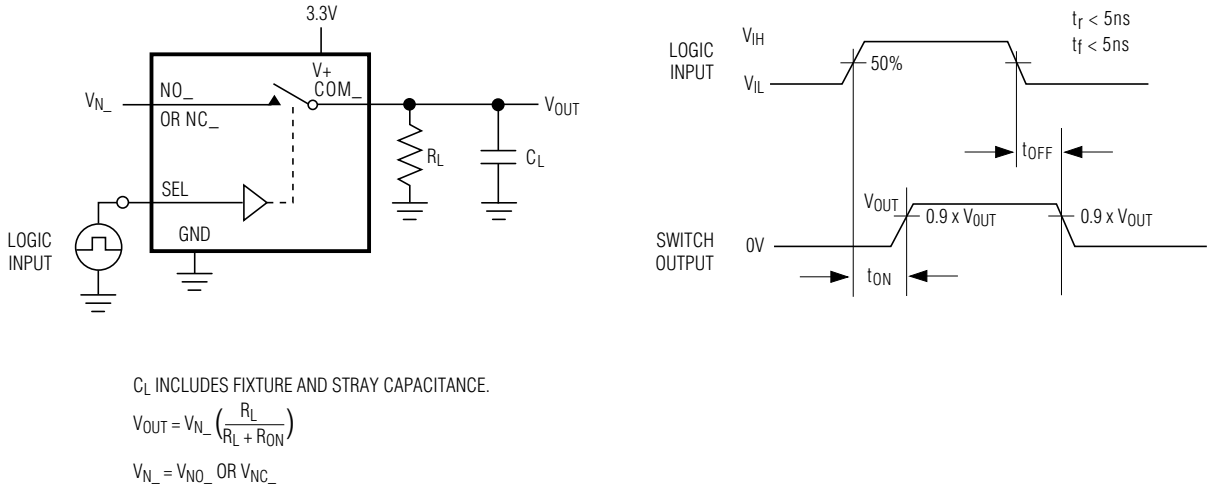
*PRBS = PSEUDORANDOM BIT SEQUENCE
†GEN I; 2.5Gps; UI = 400ps

Pin Description

PIN		NAME	FUNCTION
MAX4888	MAX4889		
1, 10, 12, 14, 20, 25, 27	1, 4, 10, 14, 17, 19, 21, 39, 41	GND	Ground
2	9	SEL	Digital Control Input
3, 9	—	N.C.	No Connection. Not internally connected.
4	2	COM1+	Analog Switch 1. Common Positive Terminal.
5	3	COM1-	Analog Switch 1. Common Negative Terminal.
6	6	COM2+	Analog Switch 2. Common Positive Terminal.
7	7	COM2-	Analog Switch 2. Common Negative Terminal.
8, 11, 13, 19, 26, 28	5, 8, 13, 18, 20, 30, 40, 42	V+	Positive-Supply Voltage Input. Connect V+ to a 1.65V to 3.6V supply voltage. Bypass V+ to GND with a 0.1µF capacitor placed as close to the device as possible. (See the *Board Layout* section).
15	31	NO2-	Analog Switch 2. Normally Open Negative Terminal.
16	32	NO2+	Analog Switch 2. Normally Open Positive Terminal.
17	33	NO1-	Analog Switch 1. Normally Open Negative Terminal.
18	34	NO1+	Analog Switch 1. Normally Open Positive Terminal.
21	35	NC2-	Analog Switch 2. Normally Closed Negative Terminal.
22	36	NC2+	Analog Switch 2. Normally Closed Positive Terminal.
23	37	NC1-	Analog Switch 1. Normally Closed Negative Terminal.
24	38	NC1+	Analog Switch 1. Normally Closed Positive Terminal.
—	11	COM3+	Analog Switch 3. Common Positive Terminal.
—	12	COM3-	Analog Switch 3. Common Negative Terminal.
—	15	COM4+	Analog Switch 4. Common Positive Terminal.
—	16	COM4-	Analog Switch 4. Common Negative Terminal.
—	22	NO4-	Analog Switch 4. Normally Open Negative Terminal.
—	23	NO4+	Analog Switch 4. Normally Open Positive Terminal.
—	24	NO3-	Analog Switch 3. Normally Open Negative Terminal.
—	25	NO3+	Analog Switch 3. Normally Open Positive Terminal.
—	26	NC4-	Analog Switch 4. Normally Closed Negative Terminal.
—	27	NC4+	Analog Switch 4. Normally Closed Positive Terminal.
—	28	NC3-	Analog Switch 3. Normally Closed Negative Terminal.
—	29	NC3+	Analog Switch 3. Normally Closed Positive Terminal.
EP	EP	EP	Exposed Paddle. Connect EP to GND.

Test Circuits/Timing Diagrams

MAXIM
MAX4888/MAX4889



C_L INCLUDES FIXTURE AND STRAY CAPACITANCE.

$V_{OUT} = V_{N\_}\left(\frac{R_L}{R_L + R_{ON}}\right)$

$V_{N\_} = V_{NO\_}$ OR $V_{NC\_}$

Figure 1. Switching Time

Test Circuits/Timing Diagrams (continued)

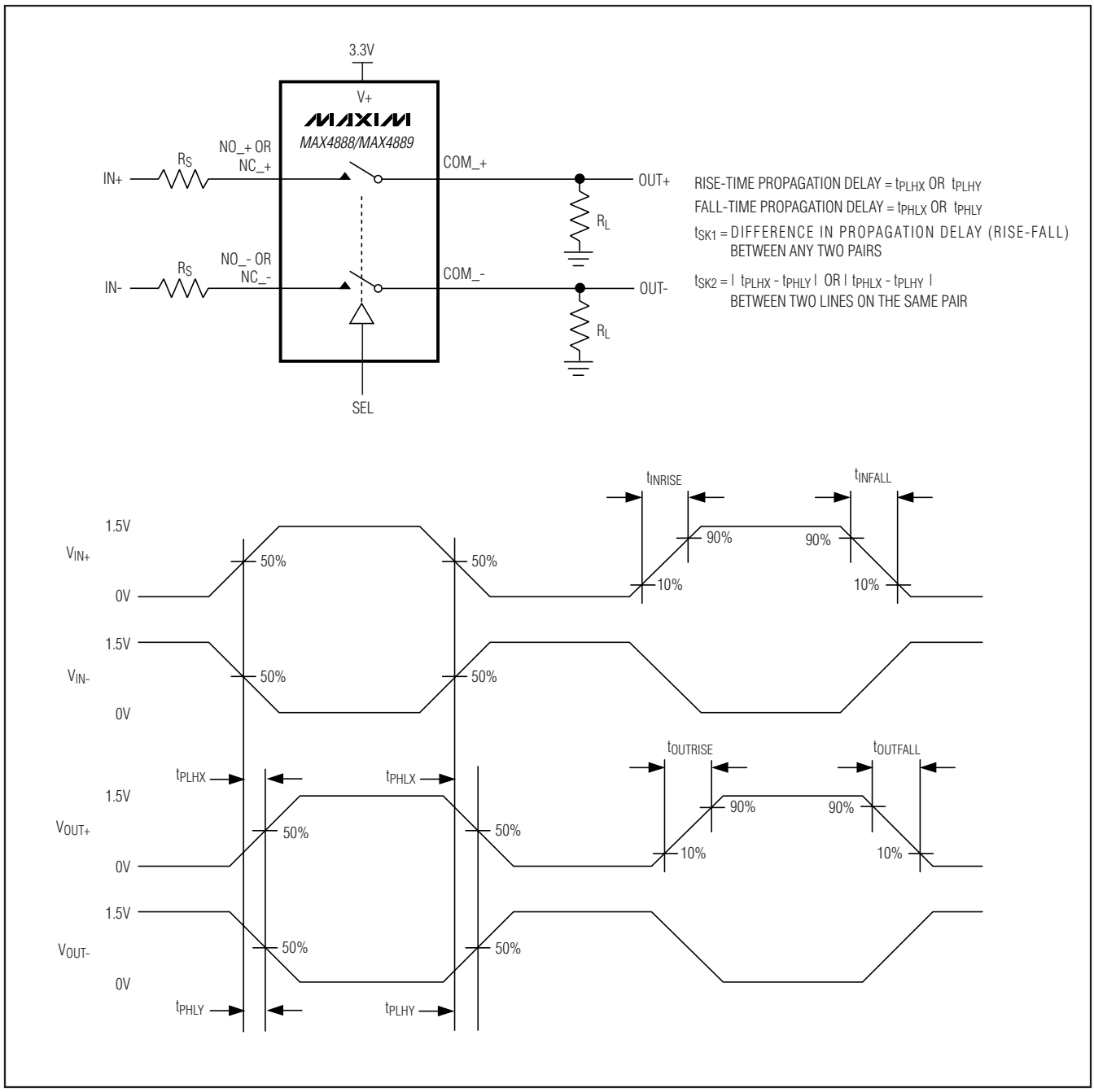


Figure 2. Propagation Delay and Output Skew

Test Circuits/Timing Diagrams (continued)

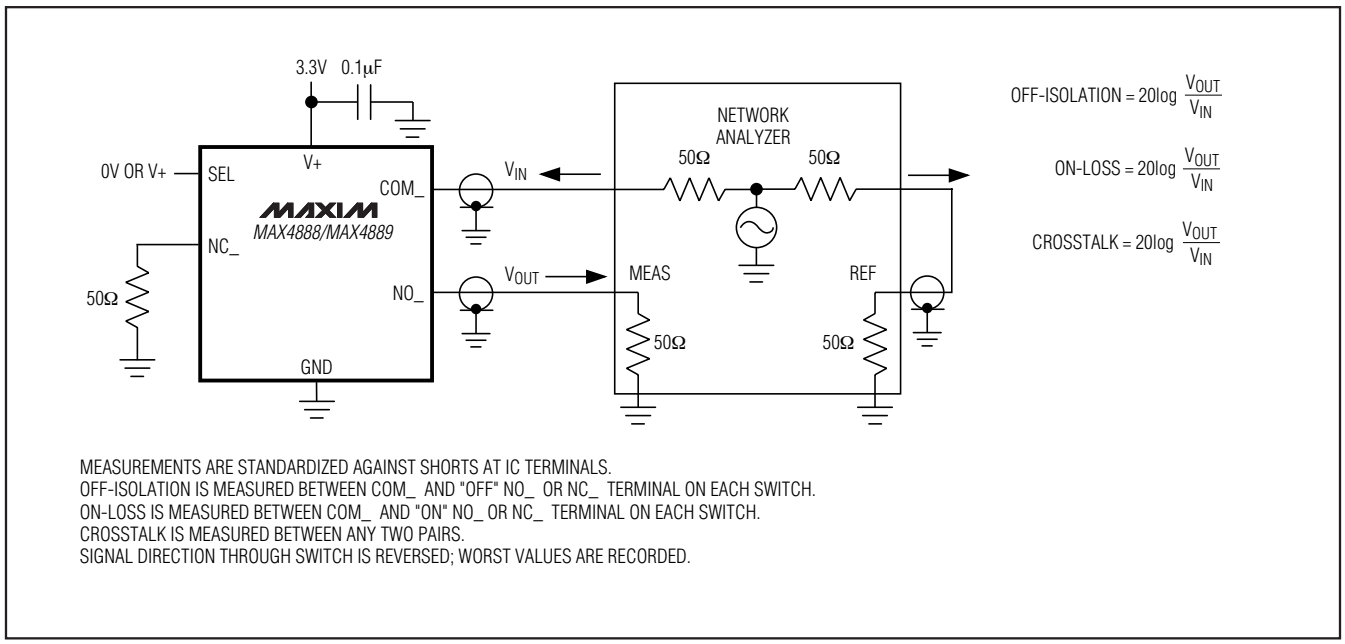


Figure 3. On-Loss, Off-Isolation, and Crosstalk

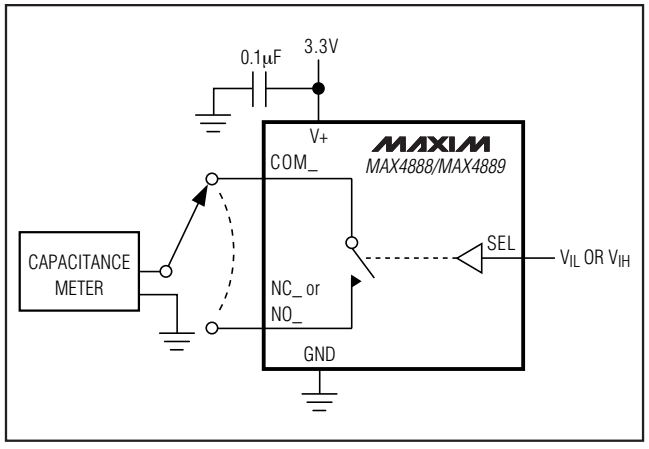


Figure 4. Channel Off-/On-Capacitance

Detailed Description

The MAX4888/MAX4889 high-speed passive switches route PCIe data between two possible destinations. The MAX4888/MAX4889 are ideal for routing PCIe signals to change the system configuration. For example, in a graphics application, the MAX4888/MAX4889 create two sets of eight lanes from a single 16-lane bus. The MAX4888/MAX4889 feature a single digital control input (SEL) to switch signal paths.

The MAX4888/MAX4889 are fully specified to operate from a single 3.0V to 3.6V power supply and also operate down to 1.65V.

Digital Control Input (SEL)

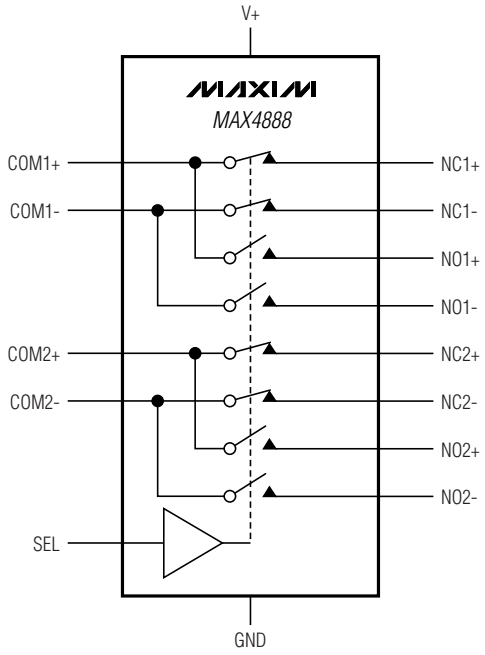
The MAX4888/MAX4889 provide a single digital control input (SEL) to select the signal path between the COM__ and NO__/NC__ channels. The truth tables for the MAX4888/MAX4889 are depicted in the *Functional Diagrams/Truth Table* section. Drive SEL rail-to-rail to minimize power consumption.

Analog Signal Levels

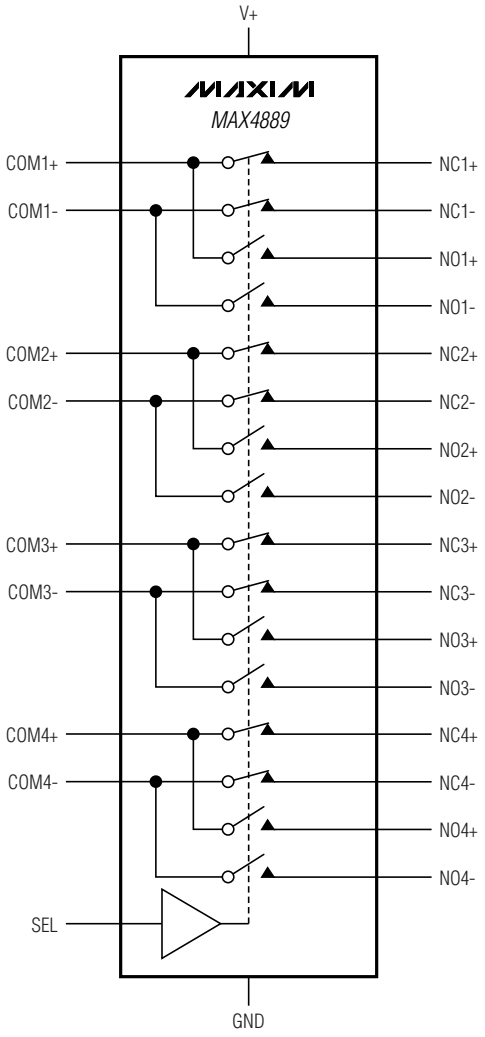
The MAX4888/MAX4889 accept standard PCIe signals to a maximum of V+ - 1.2V. Signals on the COM_+ channels are routed to either the NO_+ or NC_+ channels, and signals on the COM_- channels are routed to either the NO_- or NC_- channels. The MAX4888/MAX4889 are bidirectional switches, allowing COM__, NO__, and NC__ to be used as either inputs or outputs.

2.5Gbps PCI Express Passive Switches

Functional Diagrams/Truth Table



SEL	COM__ TO NC__	COM__ TO NO__
0	ON	OFF
1	OFF	ON



Applications Information

PCIe Switching

The MAX4888/MAX4889 primary applications are aimed at reallocating PCIe lanes (see Figure 5). For example, in graphics applications, several manufacturers have found that it is possible to improve performance by a factor of nearly two by splitting a single 16-lane PCIe bus into two 8-lane buses. Two of the more prominent examples are SLI™ (Scaled Link Interface) and CrossFire™. The MAX4889 permits a computer motherboard to operate properly with a single 16-lane graphics card, and can later be updated to dual cards. The same motherboard can be used with dual cards where the user sets a jumper or a bit through software to switch between single- or dual-card operation.

Board Layout

High-speed switches require proper layout and design procedures for optimum performance. Keep design-controlled impedance PCB traces as short as possible or follow impedance layouts per the PCIe specification. Ensure that power-supply bypass capacitors are placed as close to the device as possible. Multiple bypass capacitors are recommended. Connect all grounds and the exposed pad to large ground planes.

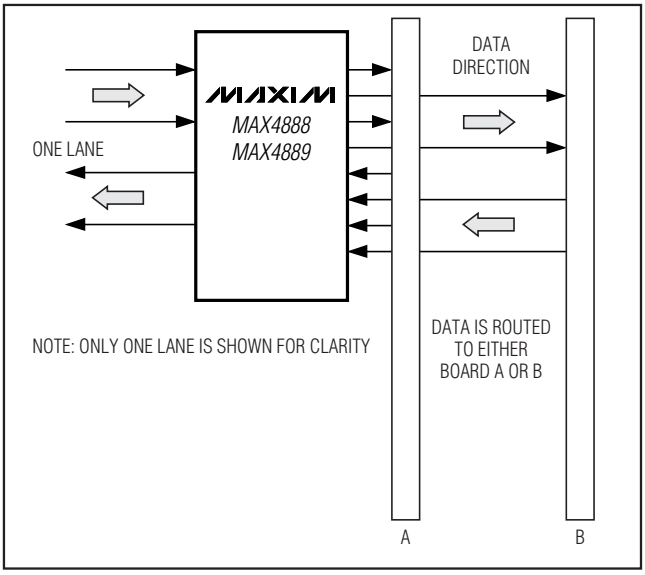


Figure 5. The MAX4888/MAX4889 Used as a Single-Lane Switch

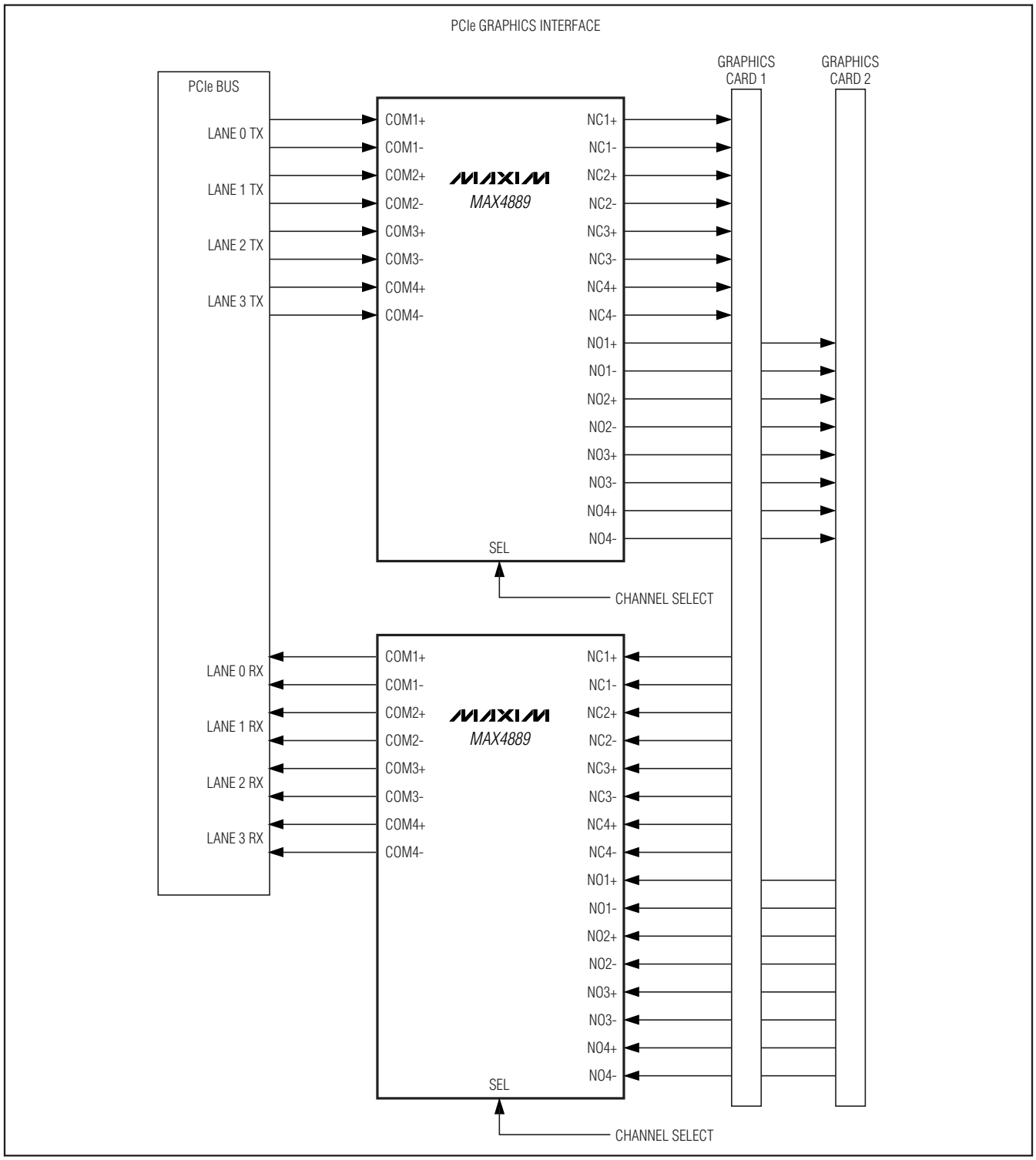
Chip Information

PROCESS: CMOS

CrossFire is a trademark of ATI Technologies, Inc.

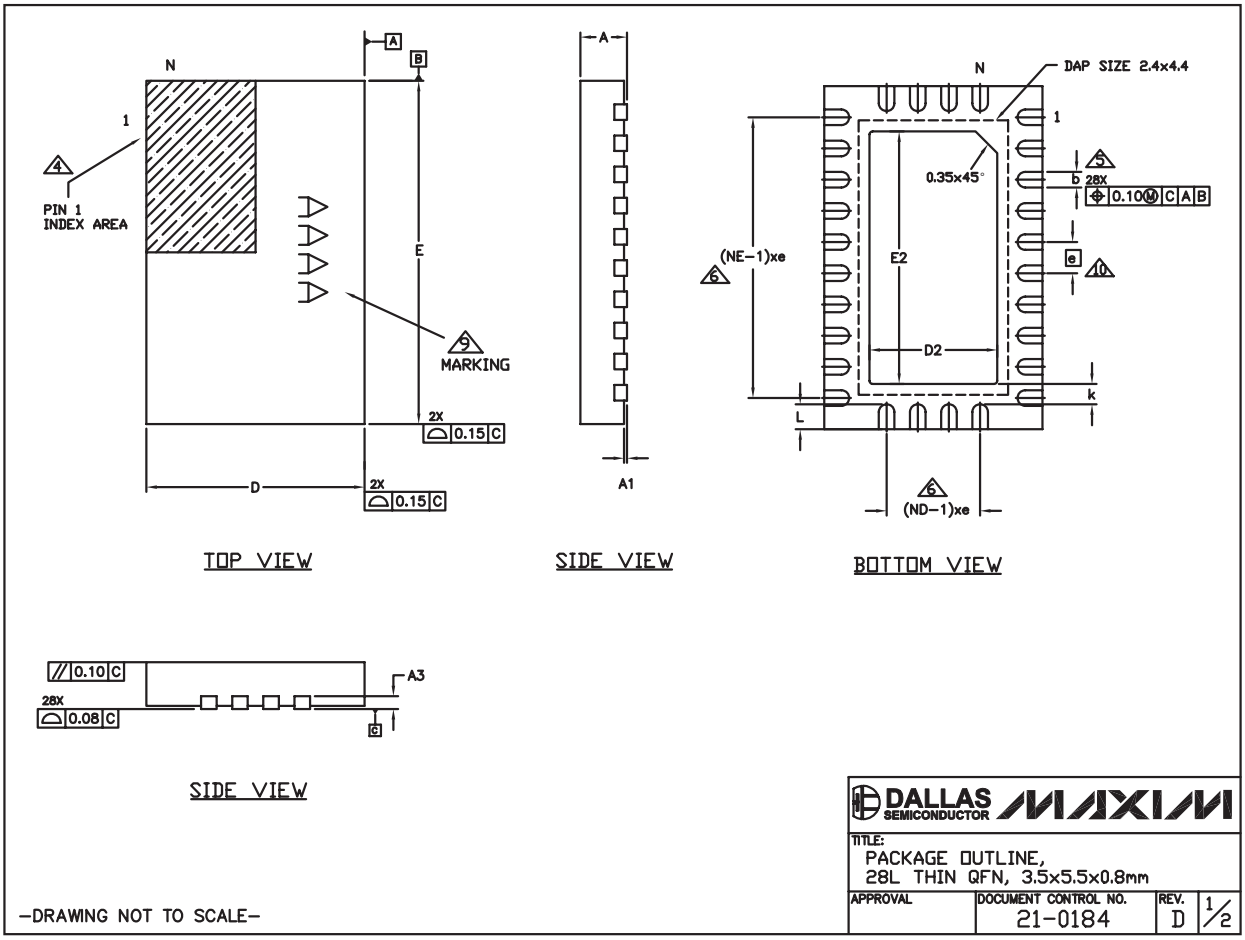
SLI is a trademark of NVIDIA Corporation.

Typical Application Circuit



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



2.5Gbps PCI Express Passive Switches

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

COMMON DIMENSIONS				
REF.	MIN.	NOM.	MAX.	NOTE
A	0.70	0.75	0.80	
A1	0	-	0.05	
A3	0.20 REF.			
b	0.20	0.25	0.30	
D	3.40	3.50	3.60	
E	5.40	5.50	5.60	
e	0.50 BSC.			
k	0.25	-	-	
L	0.30	0.40	0.50	ALL PINS
N	28			
ND	4			
NE	10			

	EXPOSED PAD VARIATIONS					
	D2			E2		
PKG. CODE	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
T283555-1	1.95	2.05	2.15	3.95	4.05	4.15

NOTES:
1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
3. N IS THE TOTAL NUMBER OF TERMINALS.
4. THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
5. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25mm AND 0.30mm FROM TERMINAL TIP.
6. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
7. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS. COPLANARITY SHALL NOT EXCEED 0.08mm.
8. WARPAGE SHALL NOT EXCEED 0.10mm.
9. MARKING IS FOR PACKAGE ORIENTATION PURPOSE ONLY.
10. LEAD CENTERLINES DEFINED BY DIMESION e±0.05.

-DRAWING NOT TO SCALE-

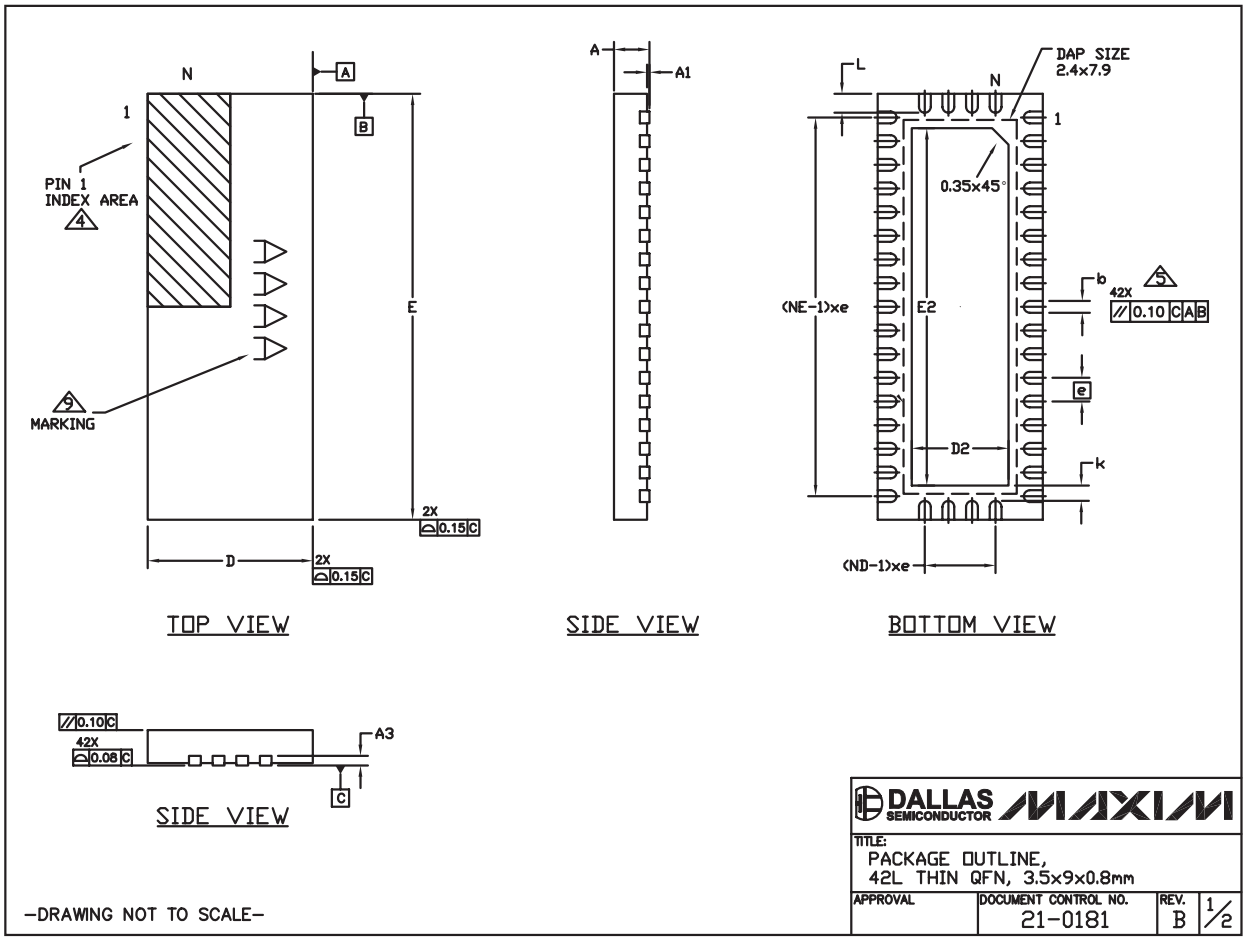
DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 28L THIN QFN, 3.5x5.5x0.8mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0184	D	2/2

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)



2.5Gbps PCI Express Passive Switches

Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to **www.maxim-ic.com/packages**.)

COMMON DIMENSIONS				
REF.	MIN.	NOM.	MAX.	NOTE
A	0.70	0.75	0.80	
A1	0	-	0.05	
A3		0.20 REF.		
b	0.20	0.25	0.30	
D	3.40	3.50	3.60	
E	8.90	9.00	9.10	
e		0.50 BSC.		
k	0.25	-	-	
L	0.35	0.40	0.45	ALL PINS
N		42		
ND		4		
NE		17		

	EXPOSED PAD VARIATIONS					
	D2			E2		
PKG. CODE	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
T423590-1	1.95	2.05	2.15	7.45	7.55	7.65
T423590M-1	1.95	2.05	2.15	7.45	7.55	7.65

NOTES:
1. DIMENSIONING & TOLERANCING CONFORM TO ASME Y14.5M-1994.
2. ALL DIMENSIONS ARE IN MILLIMETERS. ANGLES ARE IN DEGREES.
3. N IS THE TOTAL NUMBER OF TERMINALS.
4. THE TERMINAL #1 IDENTIFIER AND TERMINAL NUMBERING CONVENTION SHALL CONFORM TO JESD 95-1 SPP-012. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL, BUT MUST BE LOCATED WITHIN THE ZONE INDICATED. THE TERMINAL #1 IDENTIFIER MAY BE EITHER A MOLD OR MARKED FEATURE.
5. DIMENSION b APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25mm AND 0.30mm FROM TERMINAL TIP.
6. ND AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.
7. COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS. COPLANARITY SHALL NOT EXCEED 0.08mm.
8. WARPAGE SHALL NOT EXCEED 0.10mm.
9. MARKING IS FOR PACKAGE ORIENTATION PURPOSE ONLY.
10. LEAD CENTERLINES TO BE AT DEFINED BY DIMESION e ±0.05.

-DRAWING NOT TO SCALE-

DALLAS SEMICONDUCTOR MAXIM

TITLE: PACKAGE OUTLINE, 42L THIN QFN, 3.5x9x0.8mm

APPROVAL	DOCUMENT CONTROL NO.	REV.	
	21-0181	B	2/2